Lighting Color

• Amber

LNJ412W83RA1

Hight Bright Surface Mounting Chip LED

TSS Type

Absolute Maximum Ratings $T_a = 25^{\circ}C$

Parameter	Symbol	Rating	Unit
Power dissipation	P _D	55	mW
Forward current	$I_{\rm F}$	20	mA
Pulse forward current *	I _{FP}	60	mA
Reverse voltage	V _R	4	V
Operating ambient temperature	T _{opr}	-30 to +85	°C
Storage temperature	T _{stg}	-40 to +100	°C

100

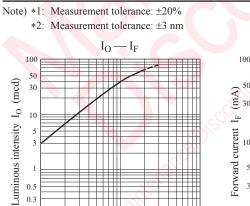
50

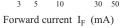
10

1.6

Electro-Optical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$

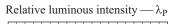
т	-30 to $+85$	°C				
1 opr	-30 10 1 03	C				
T _{stg}	-40 to +100	°C				
width 1 mse	c.					
= 25°C±3°	С		Ko.			
Symbol		Conditions	Min	Тур	Max	Unit
Io	$I_{\rm F} = 10 {\rm mA}$		21	38	104	mcd
I _R	$V_R = 4 V$	0100			100	μΑ
V _F	$I_F = 10 \text{ mA}$			2.0	2.5	V
$\lambda_{\rm P}$	$I_F = 10 \text{ mA}$			595	~	nm
λ_d	$I_F = 10 \text{ mA}$	Milles the	584	590	596	nm
Δλ	$I_F = 10 \text{ mA}$	alle des e	e O	15	Co.	nm
	width 1 mse = $25^{\circ}C \pm 3^{\circ}C$ Symbol I_{O} I_{R} V_{F} λ_{P} λ_{d}	T_{stg} -40 to +100 width 1 msec. = 25°C±3°C Symbol I _O I _F = 10 mA I _R V _R = 4 V V _F I _F = 10 mA λ_P I _F = 10 mA λ_d I _F = 10 mA	$\begin{array}{c c c c c c c c c c c c c c c c c c c $	$\begin{tabular}{ c c c c c c c } \hline T_{stg} & -40 to +100 & ^{\circ}C$ \\ \hline $width 1 msec.$ \\ \hline $= 25^{\circ}C \pm 3^{\circ}C$ \\ \hline $Symbol$ & $Conditions$ & Min \\ \hline I_{O} & $I_{F} = 10 mA$ & 21 \\ \hline I_{R} & $V_{R} = 4 V$ & V \\ \hline V_{F} & $I_{F} = 10 mA$ & 21 \\ \hline λ_{P} & $I_{F} = 10 mA$ & 584 \\ \hline λ_{d} & $I_{F} = 10 mA$ & 584 \\ \hline \end{tabular}$	$\begin{tabular}{ c c c c c c c c c c c c c c c c c c c$	$\begin{tabular}{ c c c c c c c c c c c c c c c c c c c$

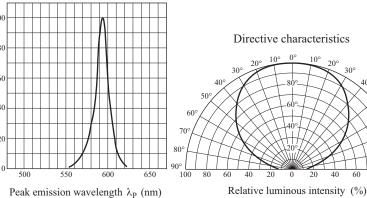


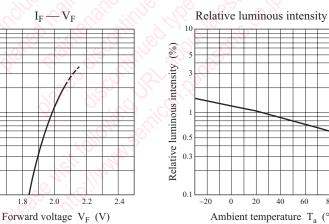


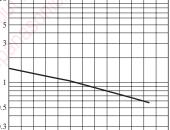
3

30 50 100



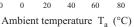


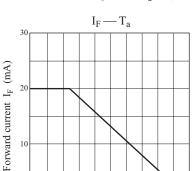




- Ta

100





10

0 6

20

40

60

Ambient temperature T_a (°C)

80

80°

909

100

0.1

100

80

60

40

20

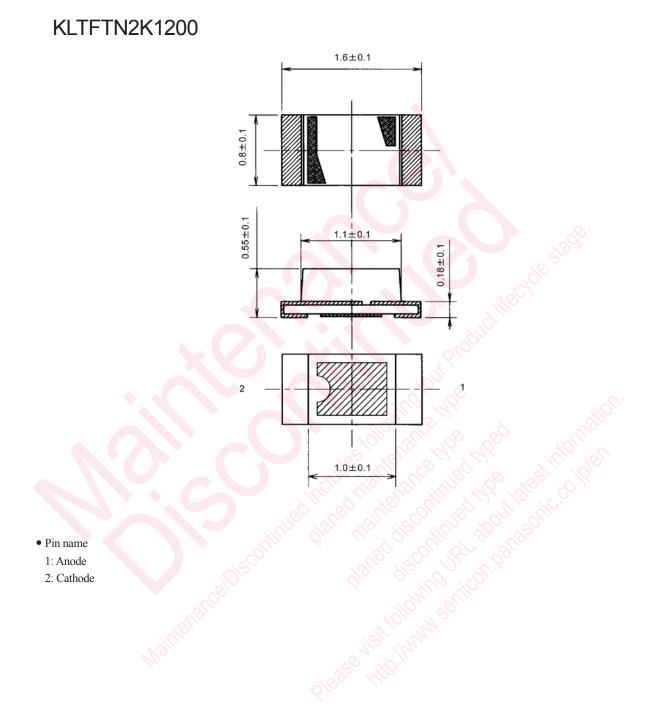
Relative luminous intensity (%)

40

100

LNJ412W83RA1

Package (Unit: mm)



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